



3401-30V,48mΩ,-4.2A,Single P-Channel

1.Features

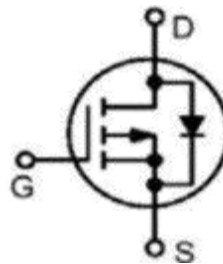
- ◆High power and current handing capability
- ◆Surface mount package

2.Applications

- ◆Power Management
- ◆Load Switching



Pin Description



Schematic Diagram

3.Absolute Max Ratings at Ta=25℃(Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	V_{DS}	-30	V
Gate to Source Voltage	V_{GS}	±12	V
Drain Current(DC)	I_D	-4.2	A
Drain Current(Pulse), $PW \leq 300\mu s$	I_{DP}	-30	A
Total Dissipation	P_D	1.2	W
Junction Temperature	T_J	150	℃
Storage Temperature	T_{stg}	-55 to+150	℃

Note 1:Stresses exceeding those listed in the Maximum Ratings table may damage the device.If any of these limits are exceeded,device functionality should not be assumed,damage may occur and reliability may be affected.

4.Thermal Resistance Ratings(Note 2)

Parameter	Symbol	Value	Unit
Thermal Resistance,Junction-to-Ambient	$R_{\theta JA}$	104	℃/W

Note 2 : When mounted on 1 inch square copper board $t \leq 10\text{sec}$ The value in any given application depends on the user's specific board design.

型号 封装
 QN3401 SOT23-3L 代表是大体积
 QN3401S SOT23 代表是小体积
 QN为QNHCH IIP



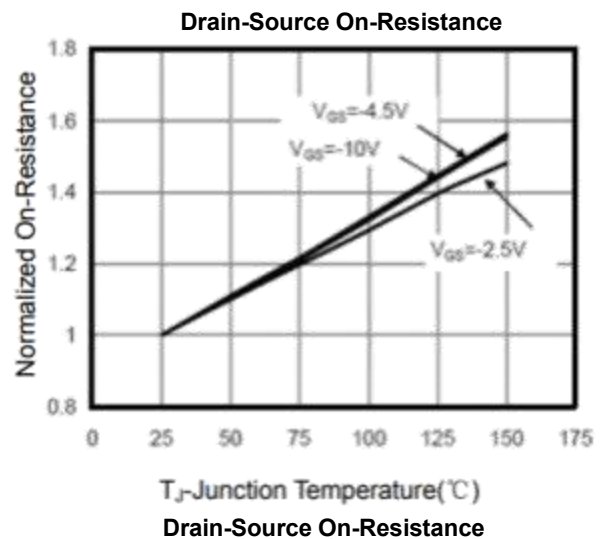
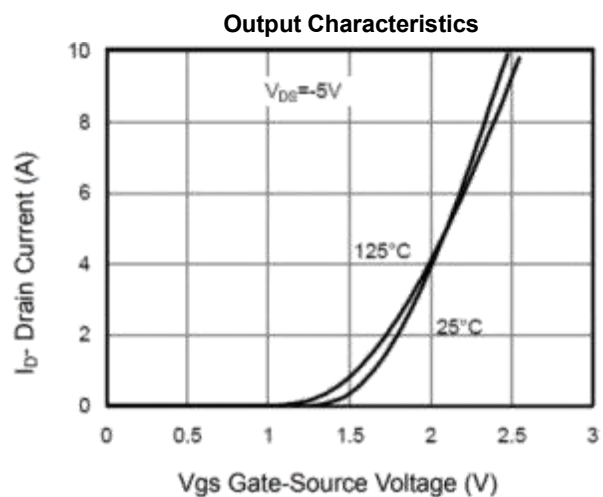
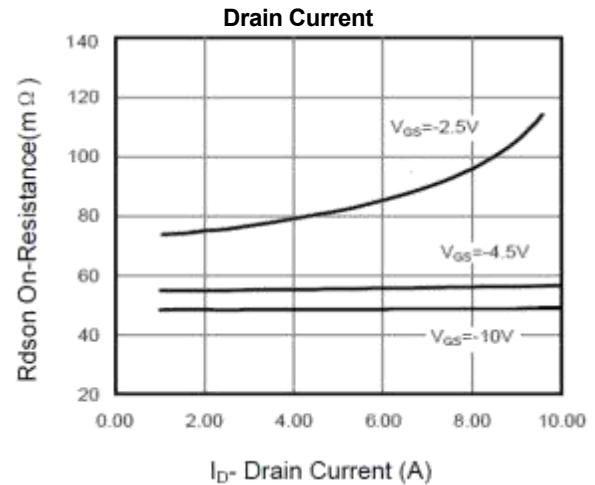
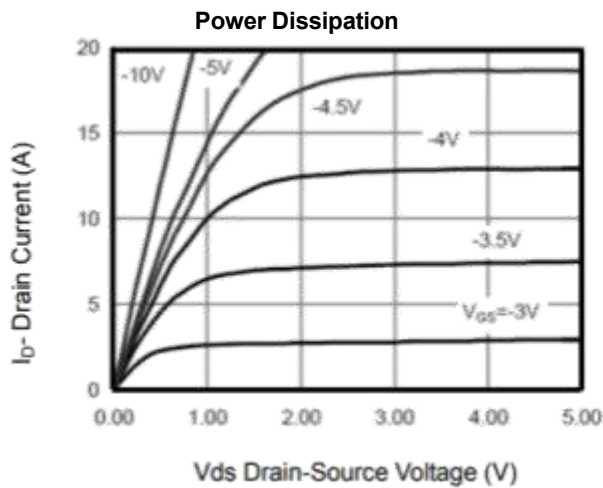
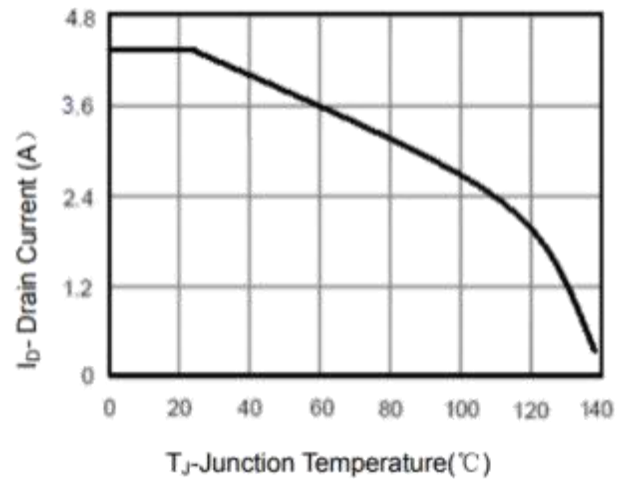
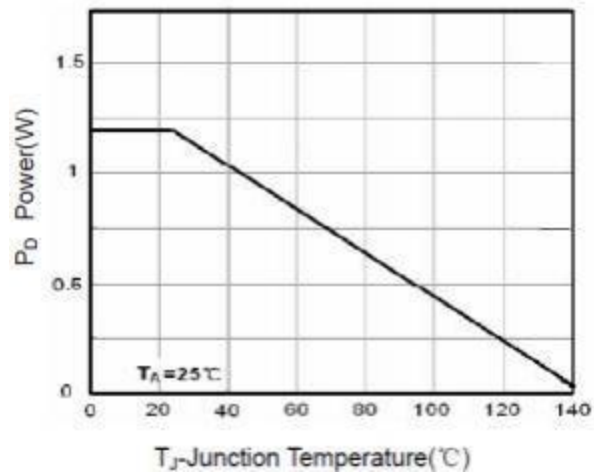
5. Electrical Characteristics at Ta=25 °C (Note 3)

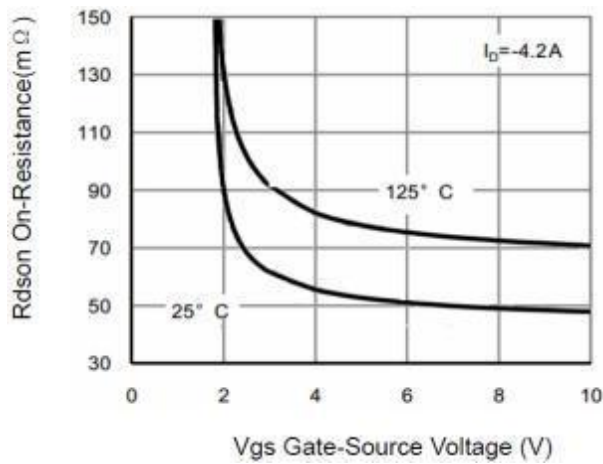
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = -250\mu A, V_{GS} = 0V$	-30			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24V, V_{GS} = 0V$			-1	μA
Gate to Source Leakage Current	I_{GSS}	$V_{GS} = \pm 10V, V_{DS} = 0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{DS} = -250\mu A$	-0.7	-1	1.3	V
Static Drain to Source On-State Resistance	$R_{DS(on)}$	$I_D = -4.2A, V_{GS} = -10V$		48	55	m Ω
		$I_D = -4A, V_{GS} = -4.5V$		56	75	m Ω
		$I_D = -1A, V_{GS} = -2.5V$		72	90	m Ω
Forward Transconductance	g_{fs}	$V_{DS} = -5V, I_D = -4.2A$		10		S
Input Capacitance	C_{iss}	$V_{GS} = 0V,$ $V_{DS} = -15V,$ Frequency = 1.0MHz		880		pF
Output Capacitance	C_{oss}			105		pF
Reverse Transfer Capacitance	C_{rss}			65		pF
Turn-ON Delay Time	$t_{d(on)}$	$V_{DS} = -15V, I_D = -4.2A, V_{GS} = -10V, R_{GEN} = 6\Omega$		7		ns
Rise Time	t_r			3		ns
Turn-OFF Delay Time	$t_{d(off)}$			30		ns
Fall Time	t_f			12		ns
Total Gate Charge	Q_g	$V_{DS} = -15V,$ $V_{GS} = -4.5V, I_D = -4.2A$		8.5		nC
	Q_{gs}			1.8		nC
	Q_{gd}			2.7		nC
Diode Forward Voltage	V_{FSD}	$I_S = -4.2A, V_{GS} = 0$			-1.2	V

Note 3 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

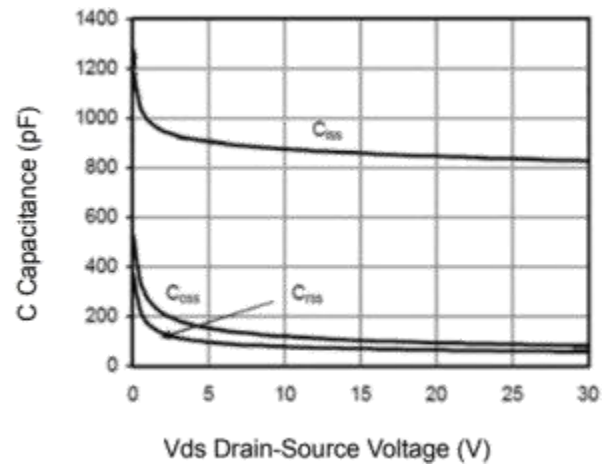


6. Typical Electrical and Thermal Characteristics

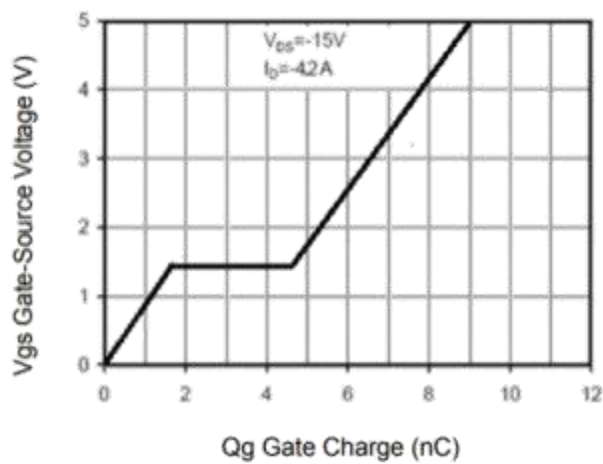




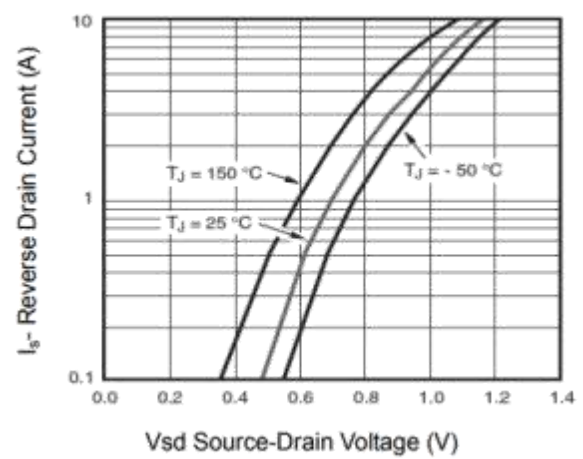
Rdson vs.Vgs



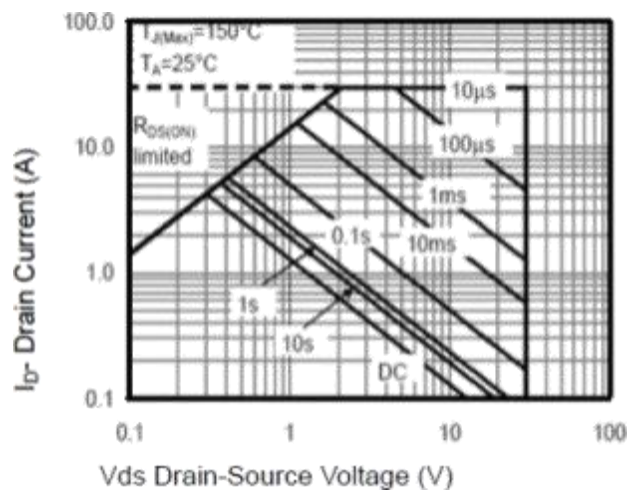
Capacitance vs.Vds



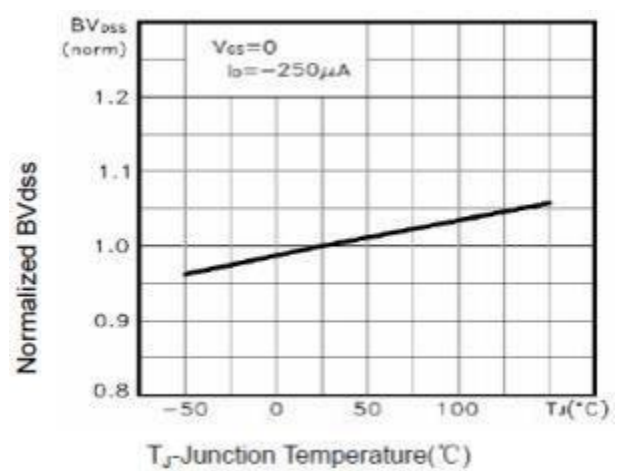
Gate Charge



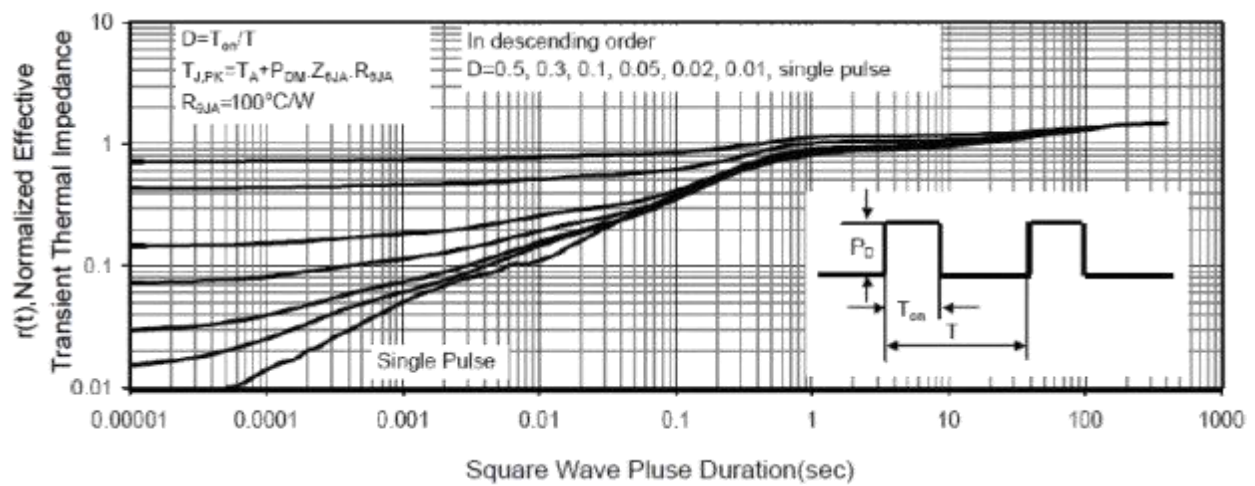
Source-Drain Diode Forward



Safe Operation Area

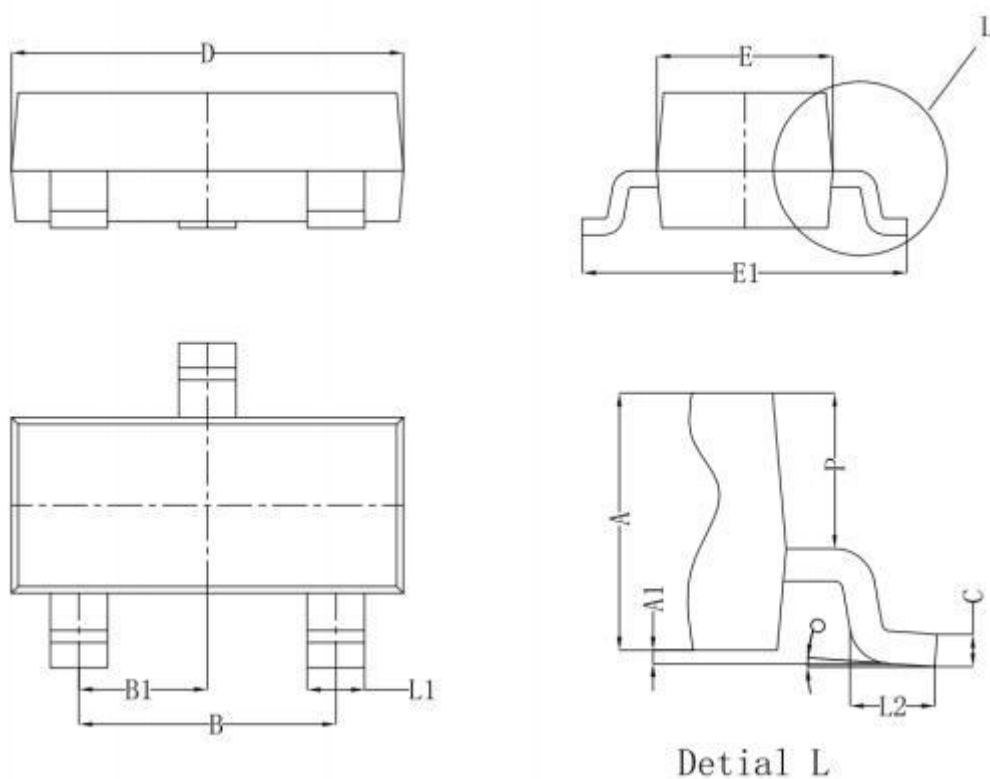


BVdss vs.Junction Temperature



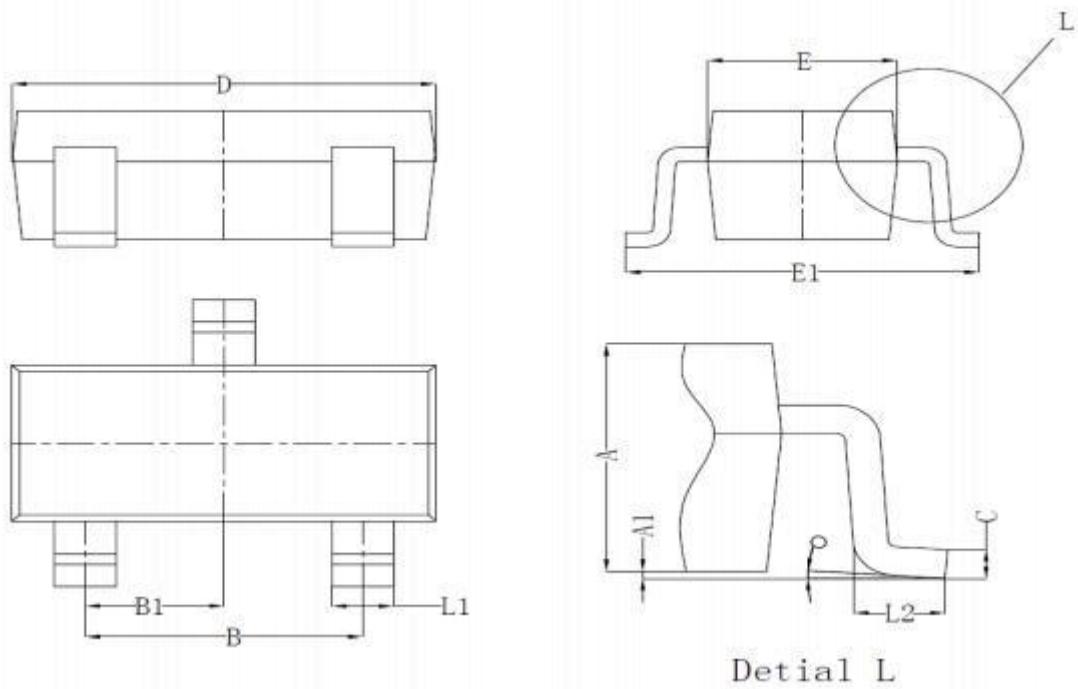
Normalized Maximum Transient Thermal Impedance

7.Dimensions(SOT-23)



Symbol	Dim in mm		
	Min	Nor	Max
A	0.900	1.000	1.100
A1	0.000	0.050	0.100
L1	0.350	0.400	0.500
C	0.100	0.110	0.120
D	2.800	2.900	3.000
E	1.250	1.300	1.350
E1	2.250	2.400	2.550
B	1.800	1.900	2.000
B1	0.950 TYP		
L2	0.200	0.350	0.450
P	0.550	0.575	0.600

8●Dimensions SOT-23-3L)



Symbol	Dim in mm		
	Min	Nor	Max
A	1.050	1.100	1.150
A1	0.000	0.050	0.100
L1	0.300	0.400	0.500
C	0.100	0.150	0.200
D	2.820	2.920	3.020
E	1.500	1.600	1.700
E1	2.650	2.800	2.950
B	1.800	1.900	2.000
B1	0.950 TYP		
L2	0.300	0.450	0.600
○	0°	4°	8°